#### 502543513 10/23/2013

### PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
SHIH-WEI LIANG	10/16/2013
HSIN-YU PAN	10/16/2013
KAI-CHIANG WU	10/16/2013
CHING-FENG YANG	10/16/2013
MING-KAI LIU	10/16/2013
CHIA-CHUN MIAO	10/16/2013

### **RECEIVING PARTY DATA**

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY LTD.	
Street Address:	NO.8, LI-HSIN RD. 6, HSINCHU SCIENCE PARK	
City:	HSINCHU	
State/Country:	TAIWAN	

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14061615

### **CORRESPONDENCE DATA**

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NAME OF SUBMITTER:	ANTHONY KING

**PATENT** REEL: 031464 FRAME: 0727

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Signature:	/ANTHONY KING/
Date:	10/23/2013
Total Attachments: 3 source=US2855-ASSG#page1.tif source=US2855-ASSG#page2.tif source=US2855-ASSG#page3.tif	

PATENT REEL: 031464 FRAME: 0728

## **ASSIGNMENT**

WHEREAS, I(we), <u>LIANG SHIH-WEI</u>, <u>PAN, HSIN-YU</u>, <u>WU, KAI-CHIANG</u>, <u>YANG CHING-FENG</u>, <u>LIU, MING-KAI</u> and <u>MIAO</u>, <u>CHIA-CHUN</u>, whose post office address(es) appear(s) below, hereinafter referred to as ASSIGNOR, have invented certain new and useful invention entitled

# SEMICONDUCTOR STRUCTURE AND MANUFACTURING METHOD THEREOF

(hereinafter referred to as the INVENTION) for which an application for United States Letters Patent /Utility Patent is executed on even date herewith unless at least one of the following is checked:

☐ United States Design Patent was

☐ executed on:
☐ filed on: Serial No.:
☐ established by PCT International Patent Application No.: filed: designating the United States of America
☐ issued on \_\_\_\_\_ as U.S. Patent No.:\_\_\_\_\_\_\_

WHEREAS, <u>TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY LTD.</u> whose post office address is <u>NO.8</u>, <u>LI-HSIN RD. 6</u>, <u>HSINCHU SCIENCE PARK</u>, <u>HSINCHU</u>, <u>TAIWAN</u>, <u>R.O.C.</u> hereinafter referred to as ASSIGNEE, is desirous of acquiring the entire right, title and interest in and to the same in the United States and its territorial possessions;

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, I (we), ASSIGNOR, by these presents do sell, assign and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application for the full term or terms for which the same may be granted, including all priority rights under any International Convention.

ASSIGNOR further covenants that no assignments, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment;

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) in the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE'S expense, to identify and communicate to ASSIGNEE at ASSIGNEE'S request documents and information concerning the INVENTION that are within ASSIGNOR'S possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance, litigation and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR'S heirs, executors, administrators and other legal representatives.

ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all Letters Patent referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE'S sole use and behoof; and for the use and behoof of ASSIGNEE'S legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

Assignor Name LIANG, SHIH-WEI	Address NO.211, WENWU RD., DAJIA TOWNSHIP, TAICHUNG COUNTY 437, TAIWAN (R.O.C.)
Signature of Assignor Shih-Wei Waru	Date of Signature ≥013, 10, 16
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

PATENT REEL: 031464 FRAME: 0729

Assignor Name PAN, HSIN-YU	Address 3F, NO.23, LN 1, SECTION 4, CHENG-TEG RD, TAIPEI, TAIWAN (R.O.C.)
g Signature of Assignor	Date of Signature
Name of Wilness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

Assignor Name WU, KAI-CHIANG	Address NO.25, NANZHONG ST., NORTH DIST., HSINCHU CITY 300, TAIWAN (R.O.C.)
Signature of Assignor WW, Wa: - Owang	Date of Signature
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

Assignor Name YANG, CHING-FENG	Address 3F., NO.11, ALY. 22, LN. 66, SEC. 5, NANJING E. RD., SONGSHAN DIST., TAIPEI CITY 105, TAIWAN (R.O.C.)
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Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

Assignor Name LIU, MING-KAI	Address NO.119, CHAJIAO, SANXIA DIST., NEW TAIPEI CITY 237, TAIWAN (R.O.C.)
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Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

Assignor Name . MIAO, CHIA-CHUN	Address 168, PARK AVE. 2, HSINCHU SCIENCE PARK HSINCHU COUNTY 308-44, TAIWAN (R.O.C.)
Signature of Assignor Wia Omn Mia o	V Date of Signature VO(5, (0, (6
Name of Witness (optional)	Name of Witness (optional)
. Signature of Witness (optional)	Signature of Witness (Optional)

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